

UNISONIC TECHNOLOGIES CO., LTD

1NM70-S Preliminary Power MOSFET

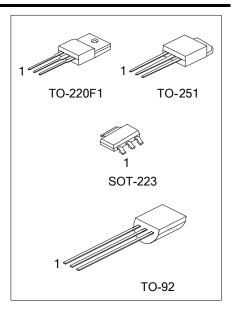
1.0A, 700V N-CHANNEL SUPER-JUNCTION MOSFET

■ DESCRIPTION

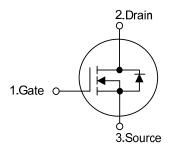
The **UTC 1NM70-S** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at DC-DC, AC-DC converters for power applications.

■ FEATURES

- * $R_{DS(ON)}$ < 4.3 Ω @ V_{GS} = 10V, I_{D} =0.5A
- * Fast switching capability
- * Avalanche energy specified
- * Improved dv/dt capability, high ruggedness



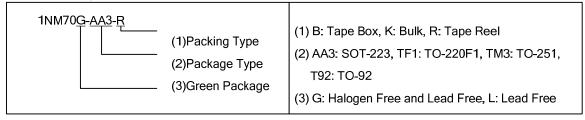
■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Dookogo	Pin Assignment			Dooking
Lead Free	Halogen Free	Package	1	2	3	Packing
1NM70L-AA3-R	1NM70G-AA3-R	SOT-223	G	D	S	Tape Reel
1NM70L-TF1-R	1NM70G-TF1-R	TO-220F1	G	D	S	Tape Reel
1NM70L-TM3-R	1NM70G-TM3-R	TO-251	G	D	S	Tape Reel
1NM70L-T92-B	1NM70G-T92-B	TO-92	G	D	S	Tape Box
1NM70L-T92-K	1NM70G-T92-K	TO-92	G	D	S	Bulk

Note: Pin Assignment: G: Gate D: Drain S: Source



<u>www.unisonic.com.tw</u> 1 of 7

■ MARKING

Package	Marking			
SOT-223	L: Lead Free G: Halogen Free Lot Code Data Code			
TO-220F1 / TO-251	UTC 1NM70□ C: Lead Free C: Halogen Free Lot Code Data Code			
TO-92	UTC 1NN70 L: Lead Free G: Halogen Free Lot Code Data Code			

■ **ABSOLUTE MAXIMUM RATINGS** (T_C = 25°C, unless otherwise specified)

PARAM	METER	SYMBOL RATINGS		UNIT
Drain-Source Voltage		V_{DSS}	700	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I _D	1.0	Α
Drain Gurrent	Pulsed (Note 2)	I_{DM}	4	Α
Avalanche Current (Note	Avalanche Current (Note 2)		0.77	Α
Avalanche Energy	Single Pulsed (Note 3)	E _{AS}	41	mJ
Peak Diode Recovery dv/	dt (Note 4)	dv/dt	4.5	
Peak Diode Recovery dv/d	SOT-223		8	W
Dower Dissipation	TO-220F1	В	21	W
Power Dissipation	TO-251	P_D	28	W
	TO-92		1.6	W
Junction Temperature		T _J +150		°C
Storage Temperature	torage Temperature		-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 3. L=138mH, I_{AS} =0.77A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} = 25°C
- 4. $I_{SD} \le 1.0A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL CHARACTERISTICS

PARAM	IETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	SOT-223		150	°C/W
	TO-220F1	θ_{JA}	62.5	°C/W
	TO-251		110	°C/W
	TO-92		180	°C/W
Junction to Case	SOT-223	θјс	15.6	°C/W
	TO-220F1		5.95	°C/W
	TO-251		4.46	°C/W
	TO-92		78	°C/W

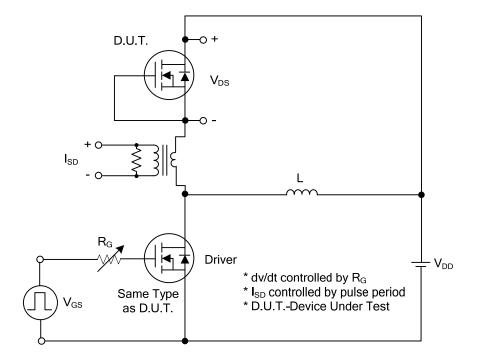
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV _{DSS}	$V_{GS} = 0V, I_D = 250\mu A$	700			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS} = 700V, V_{GS} = 0V$			10	μΑ
Gate-Source Leakage Current	Forward	- I _{GSS}	$V_{GS} = 30V, V_{DS} = 0V$			100	nA
	Reverse		$V_{GS} = -30V, V_{DS} = 0V$			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2.5		4.5	V
Static Drain-Source On-State Res	istance	R _{DS(ON)}	V _{GS} = 10V, I _D =0.5A			4.3	Ω
DYNAMIC CHARACTERISTICS		_			=.	-	
Input Capacitance	Input Capacitance				116		pF
Output Capacitance		Coss	V_{DS} =25V, V_{GS} =0V, f =1MHz		62		pF
Reverse Transfer Capacitance		C_{RSS}			8		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q_G	V _{DS} =50V, V _{GS} =10V, I _D =0.5A I _G =100μA (Note 1, 2)		14.6		nC
Gate-Source Charge		Q_GS			1.5		nC
Gate-Drain Charge		Q_GD	IG-100μΑ (Note 1, 2)		4.5		nC
Turn-On Delay Time (Note 1)		t _{D (ON)}			37		ns
Turn-On Rise Time		t_{R}	V_{DD} =30V, V_{GS} =10V, I_{D} =0.5A,		38		ns
Turn-Off Delay Time		t _{D(OFF)}	$R_G = 25\Omega$ (Note 1, 2)		63		ns
Turn-Off Fall Time		t_{F}			19		ns
DRAIN-SOURCE DIODE CHARA	CTERISTICS						
Continuous Drain-Source Current		Is				1.0	Α
Maximum Body-Diode Pulsed Current		I _{SM}				4.0	Α
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I _S =1.0A, V _{GS} =0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t _{rr}	I _S =1.0A, V _{GS} =0V,		162		nS
Body Diode Reverse Recovery Charge		Qrr	dI _F /dt=100A/μs		0.7		μC

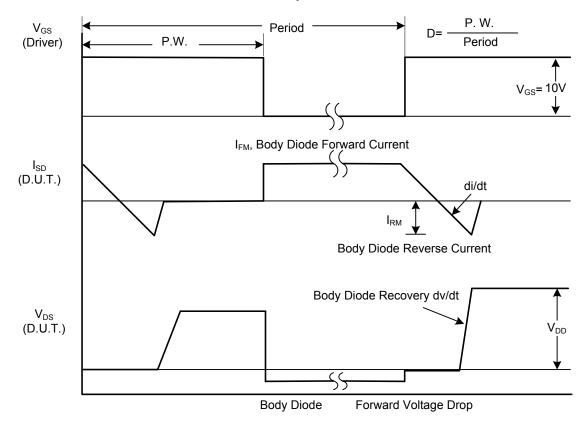
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle≤2%.

^{2.} Essentially independent of operating temperature.

TEST CIRCUITS AND WAVEFORMS

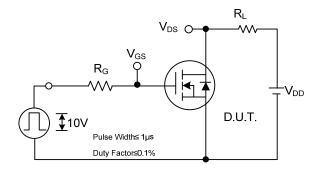


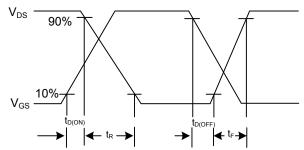
Peak Diode Recovery dv/dt Test Circuit



Peak Diode Recovery dv/dt Waveforms

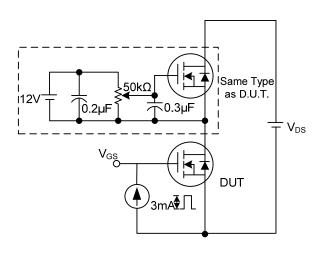
■ TEST CIRCUITS AND WAVEFORMS (Cont.)

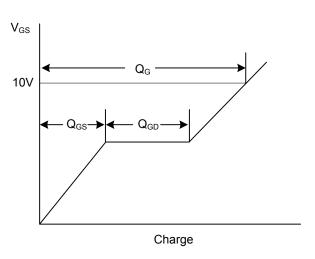




Switching Test Circuit

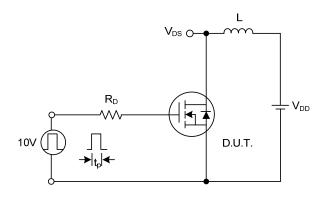
Switching Waveforms

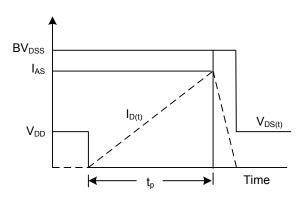




Gate Charge Test Circuit

Gate Charge Waveform





Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

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